

SMT power inductors

PID differential mode inductors

Series/Type: PID*-251M Date: September 2022

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Tél. 01 47 95 99 89 Fax. 01 47 05 Fax. 01 47 01 16 22



e-mail : comp@es-france.com Site Web : www.es-france.com

ES France - Département Composants & Modules 127 rue de Buzenval BP 26 - 92380 Garches

les Kine Stein Contraction (1997) Tél. 01 47 95 99 89 Fax. 01 47 01 16 22 e-mail : comp@es-france.com Site Web : www.es-france.com

SMT power inductors

Rated inductance 2 x 250 µH

PID differential mode inductors

Construction

- Ferrite core
- Magnetically shielded
- Winding enamel copper wire
- Winding welded to terminals

Features

- Temperature range up to +150 °C
- High rated current
- Low DC resistance
- Functional isolation up to 500 V
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020E
- RoHS-compatible

Applications

- Industrial electronics
- Power over Data Line (PoDL) for 10BASE-T1L (IEEE 802.3 cg)
- Differential mode choke

Terminals

- Base material CuSn6P
- Lead-finish Sn (lead-free)
- Electro-plated

Marking

Marking on component:

PID75-251M and PID100-251M: Code letter "D", L value (in μ H), date of manufacture (YWWD), dot for Pin 1 identification

PID120L-251M and PID120H-251M: Product series, code letter "D", L value (in μ H), date of manufacture (YWWD), two last digits of production order, dot for Pin 1 identification PID150H-251M: Code letter "D", L value (in μ H), date of manufacture (YWWD), dot for Pin 1 identification

Delivery mode and packing units

- Blister tape, wound on 330-mm Ø reel
 - 16-mm blister tape for PID75-251M
 - 24-mm blister tape for PID100-251M, PID120L-251M, PID120H-251M
 - 32-mm blister tape for PID150H-251M
- Packing unit:
 - 1000 pcs./reel for PID75-251M
 - 600 pcs./reel for PID100-251M
 - 350 pcs./reel for PID120L-251M
 - 250 pcs./reel for PID120H-251M
 - 175 pcs./reel for PID150H-251M





PID*-251M

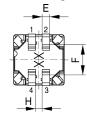
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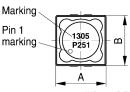
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Dimensional drawing



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- L	
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IND1889-C-E

 PID120H-251M
 1.75 ±0.2
 7.2 ±0.2

 PID150H-251M
 2.0 ±0.2
 8.0 ±0.2

А

Е

7.5 max.

10.4 max.

12.5 max.

12.5 max.

15.5 max.

0.8 ±0.1

1.5 ±0.2

1.75 ±0.2

В

F

7.5 max.

10.4 max.

12.5 max.

12.5 max.

15.5 max.

3.8 ±0.2

7.2 ±0.2

6 ±0.2

С

н

1 ±0.1

1.3 ±0.2

1.5 ±0.2

 1.5 ± 0.2

1.8 ±0.2

4.8 max.

6.3 max.

8.5 max.

10.5 max.

14.5 max.

Ordering code

PID75-251M

PID100-251M

PID120L-251M

PID120H-251M

PID150H-251M

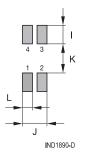
Ordering code PID75-251M

PID100-251M

PID120L-251M

Dimensions in mm

Layout recommendation



Circuit diagram



IND1998-D

Ordering code	1	J	К	L
PID75-251M	2.1	2.8	3.3	1.1
PID100-251M	2.4	4.5	5.7	1.7
PID120L-251M	3.1	5.8	6.8	2.3
PID120H-251M	3.1	5.8	6.8	2.3
PID150H-251M	4.15	6.6	7.4	2.55

Dimensions in mm







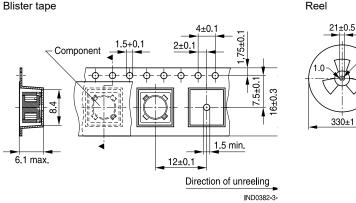


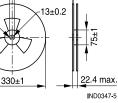
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Taping and packing

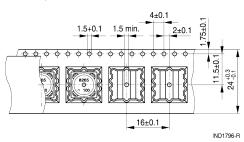
PID75-251M Blister tape

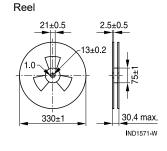




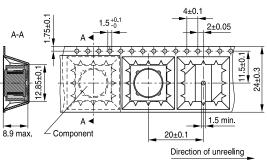
2.5±0.5

PID100-251M Blister tape





PID120L-251M Blister tape



Reel

ND0912-N-F

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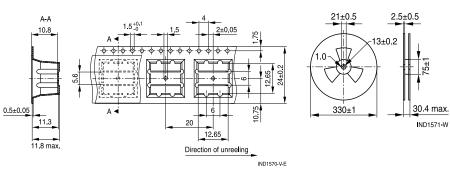
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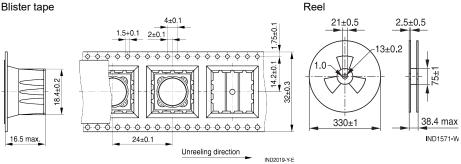
PID120H-251M

Blister tape



Reel

PID150H-251M Blister tape



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Technical data and measuring conditions

Rated inductance L_1 , L_2	Measured with LCR meter Agilent 4284A (or equivalent) at		
	frequency f_L , 0.1 V, 23 °C, 250 μ H per winding		
Tolerance	±20%		
Inductance L _{PoDL}	Typ. 1000 µH, equivalent inductance when both windings are		
	connected in series (measured in 1-4 with 2-3 shorted)		
Operating temperature range	-40 °C to +150 °C (self-rise temperature included)		
Rated current I _R	Max. typ. permissible DC with temperature increase of ≤40 K Method as per IEC62024-2, when both windings are connected in series (measured in 1-4 with 2-3 shorted)		
Saturation current I _{Sat}	DC with inductance decrease $\Delta L/L_0$ of approx. 30%, when both		
	windings are connected in series (measured in 1-4 with 2-3		
	shorted), typical values		
DC resistance R ₁ ,R ₂ , (max.)	Measured at +23 °C, is specified per winding		
Isolation (functional)	Tested with 500 V, 0.4 s by 100%; 3 s during qualification		
Solderability (lead-free)	Dip and look method,		
	Wetting of soldering area ≥95%		
	as referenced in EIA/IPC/JEDEC J-STD-002E		
Resistance to soldering heat	as referenced in JEDEC J-STD-020E		
Climatic category	40/150/56 (to IEC 60068-1)		
Storage conditions	Mounted: –40 °C +150 °C		
	Packaged: –25 °C … +40 °C, ≤75% RH		
Weight	Approx. 0.9 g for PID75-251M		
	Approx. 2.5 g for PID100-251M		
	Approx. 4.2 g for PID120L-251M		
	Approx. 5.0 g for PID120H-251M		
	Approx. 10.5 g for PID150H-251M		



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Characteristics and ordering codes

Size	IEEE 802.3 cg Power class	R _{DC,typ}	I _{Sat,typ}	I _{R,typ} (ambient temp.)	Internal code	Ordering code
mm		Ω	mA	mA		
7.5 x 7.5 x 4.8	10	2.25	360	270 (+25 °C) 250 (+85 °C) 240 (+105 °C)	B82472E6254M000	PID75-251M
10.4 x 10.4 x 6.3	11, 13	1.13	645	460 (+25 °C) 410 (+85 °C) 400 (+105 °C)	B82464E6254M000	PID100-251M
12.5 x 12.5 x 8.5	11, 13, 14	0.65	910	650 (+25 °C) 530 (+85 °C) 500 (+105 °C)	B82477E4254M000	PID120L-251M
12.5 x 12.5 x 10.5	13, 14	0.41	1160	820 (+25 °C) 675 (+85 °C) 635 (+105 °C)	B82477E6254M000	PID120H-251M
15.5 x 15.5 x 14.5	12, 14	0.27	1200	1200 (+25 °C) 1070 (+85 °C) 1040 (+105 °C)	B82480E8254M000	PID150H-251M

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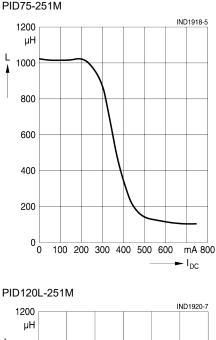
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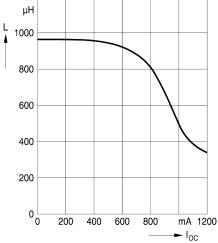
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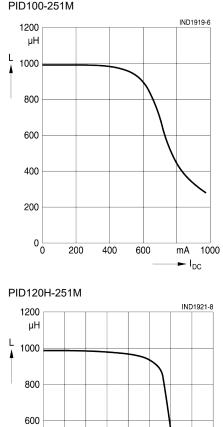
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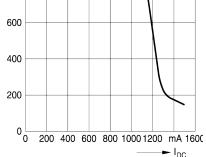
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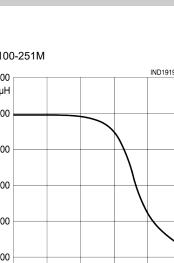
Inductance versus I_{DC} (typical values, series L)











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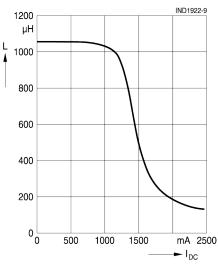
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PID150H-251M





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Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.

Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.

- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire, wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
 - Many coating materials have a negative effect (chemically and mechanically) on the winding wires, insulation materials and connecting points. Customers are always obligated to determine whether and to what extent their coating materials influence the component. Customers are responsible and bear all risk for the use of the coating material. TDK Electronics does not assume any liability for failures of our components that are caused by the coating material.
- Ceramics / ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.
- Due to product design and applied manufacturing process, appearance, symmetry, and shape of not dimensioned details could vary within same lot, as well discoloration of housing is possible. TDK does not expect detrimental effects on product function or reliability. In case of conflicts, TDK reference standard shall prevail.

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